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Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS	· ·		•		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		41		mV/ °C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $T_{J} = 55^{\circ}\text{C}$			1	μA
					10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
ON CHARA	CTERISTICS (Note)			•		
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.7	1	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		-2.3		mV/ °C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 2.2 \text{ A}$ $T_J = 125^{\circ}\text{C}$		0.054	0.065	Ω
				0.08	0.11	
		$V_{GS} = 2.5 \text{ V}, I_{D} = 2 \text{ A}$		0.07	0.082	
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	10			А
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 2.2 A$		13		S
DYNAMIC (	CHARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		300		pF
C <sub>oss</sub>	Output Capacitance			145		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			35		pF
SWITCHING	CHARACTERISTICS (Note)			T		1
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{\text{DD}} = 5 \text{ V}, \text{ I}_{\text{D}} = 1 \text{ A},$ $V_{\text{GS}} = 4.5 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		4	10	ns
ţ	Turn - On Rise Time			10	18	ns
t <sub>D(off)</sub>	Turn - Off Delay Time			17	28	ns
t,	Turn - Off Fall Time			4	10	ns
Q <sub>g</sub>	Total Gate Charge	$V_{\rm DS} = 10 \text{ V}, \ I_{\rm D} = 2.2 \text{ A},$		7	9	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 4.5 V$		1.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.9		nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS	1	1		
l <sub>s</sub>	Maximum Continuous Drain-Source Diode F	1	ļ		0.42	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 0.42 A$ (Note)		0.65	1.2	V

1. R<sub>BM</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BM</sub> is guaranteed by design while R<sub>BCA</sub> is determined by the user's board design.

а

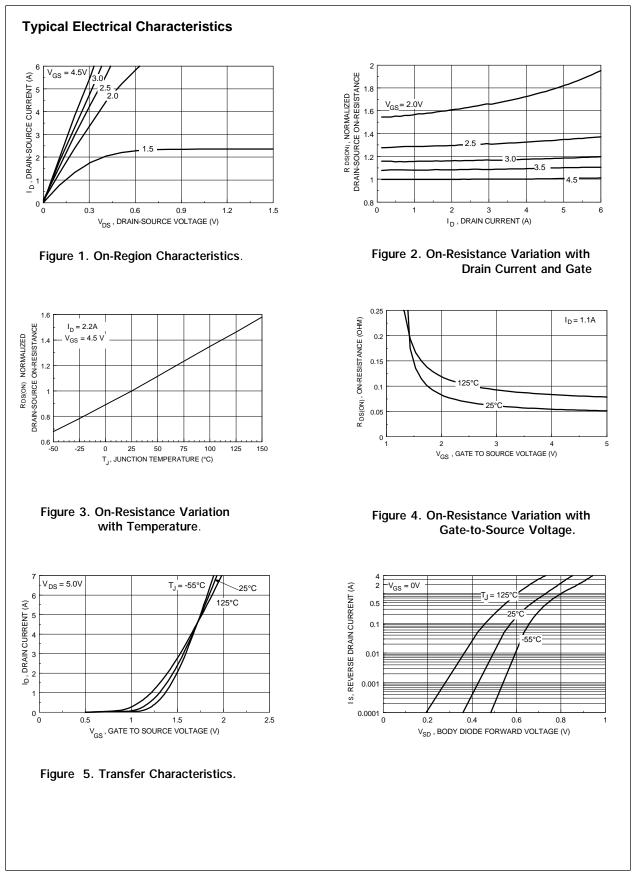
Scale 1 : 1 on letter size paper

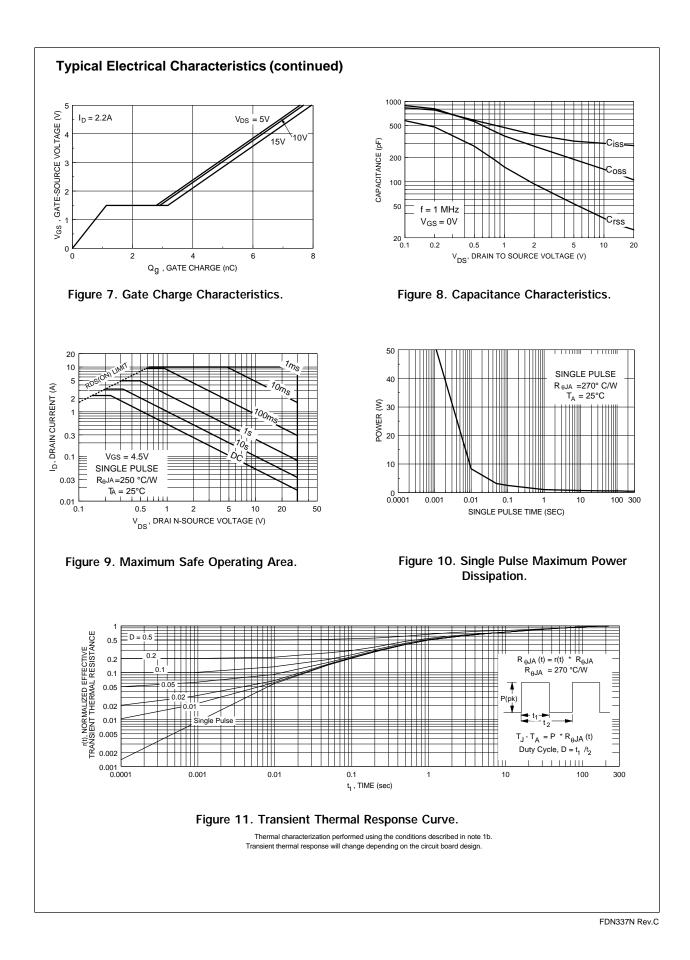
2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.



a. 250°C/W when mounted on 0.02 in<sup>2</sup> pad of 2oz Cu.

 b. 270°C/W when mounted on a 0.001 in<sup>2</sup> pad of 2oz Cu.





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